

LOCTITE ABLESTIK 561K

March 2019

PRODUCT DESCRIPTION

LOCTITE ABLESTIK 561K provides the following product characteristics:

Technology	Epoxy Film
Appearance	White
Cure	Heat cure
Product Benefits	 Thermally conductive Flexible for Bonding Mismatched Adherends Reworkable Passes NASA outgassing
Application	Assembly
Carrier Type	Glass fabric
Film Thickness	 100 to 250µ (25µ carrier) 125 to 200µ (50µ carrier) 305µ (101µ carrier)
pН	8
Typical Assembly Applications	Substrate attach and Heat sink bonding

LOCTITE ABLESTIK 561K is designed for substrate attach and heat sink bonding. This adhesive film is designed for bonding materials with severely mismatched coefficients of thermal expansion. All data and results will vary with different thicknesses.

LOCTITE ABLESTIK 561K passes NASA outgassing standards.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Work Life @ 25°C, days	183
Shelf Life @ -40°C, days	365
Flash Point - See SDS	

TYPICAL CURING PERFORMANCE

Cure Schedule

30 minutes @ 150°C

Alternate Cure Schedule

2 hours @ 125°C

Percent Volatiles

10 x 10cm sample @ 120°C for 30 minutes, % 0.16

Curing film adhesives under pressure to ensure proper wetting of the adherend surfaces is recommended. Pressure requirements will vary from (2 to 200 psi) depending on the severity of the adherends warpage and the stiffness of the adherends. Temperatures are recommended are at the bondline.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

•		
Coefficient of Thermal Expansion, ppm/°C:		
Below Tg		85
Above Tg		300
Glass Transition Temperature, °C		55
Thermal Conductivity @ 121°C, W/(m-K)		0.9
Tensile Modulus, DMTA:		
@ -65 °C	N/mm²	-,
	(psi)	(890,000)
@ 25 °C	N/mm²	,
	(psi)	, ,
@ 150 °C	N/mm²	,
0.050.80	. ,	(290,000)
@ 250 °C	N/mm²	(270,000)
Extractable Ionic Content, @ 100°C:	(psi)	(270,000)
		110
Chloride (Cl-)		35
Sodium (Na+)		
Potassium (K+)		9
Water Extract Conductivity, µmhos/cm		110
Weight Loss @ 300°C, %		0.34
Moisture Absorption @ Saturation, wt.% @ 8	35°C/85°F	RH 0.9

Electrical Properties

Volume Resistivity, ohms-cm	9.1×10 ¹²
Dielectric Strength, volts/µm	820/25
Dielectric Constant @ 1kHz	5.7
Dissipation Factor @ 1kHz	0.012

TYPICAL PERFORMANCE OF CURED MATERIAL

Lap Shear Strength:

Al to Al with 1.27cm overlap @ 25°C	N/mm² 23 (psi) (3,300)
Au to Au with 1.27cm overlap @ 25°C	N/mm ² 26 (psi) (3,700)

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

THAWING:

- 1. Allow material to reach room temperature before use.
- 2. DO NOT open the package before contents reach ambient temperature.
- Any moisture that collects on the thawed package should be removed prior to opening the package.

DIRECTIONS FOR USE

- 1. Place precut adhesive film between clean surfaces to be bonded.
- 2. Assemble components.
- Apply spring loaded clamp or dead weight to provide continuous pressure of at least 2 to 10 psi during cure cycle.
- 4. Place assembly in a preheated oven and cure at the



recommended cure schedule.

Rework Procedure

- 1. Heat component to 125°C.
- 2. Slide a thin blade between bonded surfaces.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

STORAGE:

LOCTITE ABLESTIK film products can be stored at -40°C for up to one year. The shelf life of the film is only valid when the material has been stored at the specified storage conditions. Incorrect storage conditions will degrade the performance of the material in final cured properties. Avoid flexing film when frozen.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·ft N·m x 0.738 = lb·ft N·m x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

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